

Surface Mount Glass Passivated Fast Recovery Rectifier Reverse Voltage 1000V Forward Current 2A

Features

- · Glass passivated fast recovery rectifiers
- Heatsink structure
- · Low profile, typical thickness 0.8mm
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s

Maximum Ratings (TA = 25 °C unless otherwise noted)

Parameter	Symbol	GSPF27	Unit
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	1000	V
Maximum RMS Voltage	V _{RMS}	700	V
Maximum DC Blocking Voltage	V _{DC}	1000	V
Maximum Average Forward Rectified Current	I _{F(AV)}	2.0	А
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	60	А
Rating for Fusing(t<8.3ms)	l ² t	15.0	A ² sec
Operating Junction and Storage Temperature Range	T _J , T _{STG}	- 55 to + 150	C

Electrical Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Test Conditions	Symbol	GSPF27	Unit	
Minimum Breakdown Voltage	T _A =25°C,IR=100uA	V _{BR}	1000		
Maximum Instantaneous forward voltage	I _F =2 A,T _A =25°C	V _F	1.3	V	
Maximum DC Reverse Current	T _A =25°C	I _R	1	μA	
at Rated DC Blocking Voltage	T _A =125°C		50		
Maximum Reverse	I _F =0.5A,I _R =1.0A,	۰.	250	nS	
Recovery Time	I _{rr} =0.25A	۲rr	230		
Typical Junction Capacitance	4.0 V, 1 MHz	CJ	10	pF	
	juntion to Ambient	$R_{\theta JA}^{1)}$	60		
Typical Thermal Resistance	juntion to lead	$R_{\theta JL}^{1)}$	10	°C/W	
	juntion to case	$R_{\theta JC}^{2)}$	35		

Note:1),The thermal resistance from junction to ambient or lead, mounted on P.C.B with 5×5mm copper pads,2 OZ,FR4 PCB

2), The thermal resistance from junction to case, mounted on P.C.B with recommended copper pads, 2 OZ, FR4 PCB



iSGA (SOD-123HS)

GSPF27





Ratings and Characteristics Curves



Figure 1. Forward Current Derating Curve



Figure 3. Typical Reverse Characteristics



Figure 5. Typical Junction Capacitance



Figure 2.Maximum Non-Repetitive Peak Forward Surge Current



Figure 4. Typical Instantaneous Forward Characteristics

Instantaneous Forward Current (A)



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Package Outline Dimensions







Package	iSGA		
Unit:mm	MIN	MAX	
А	0.75	0.90	
В	0.85	1.05	
B1	0.85	1.05	
С	0.1	0.25	
D	1.9	2.1	
E	2.9	3.1	
L1	2.0	2.45	
L2	0.4	0.85	
L3	1.3	1.7	
HE	3.5	3.9	

Soldering footprint



Packing Information

Packing Quantities:

Reel size	Quantity/reel	Quantity/inner Box	Quantity/Carton
7"	ЗK	30K	120K

Packing Tape Specification

